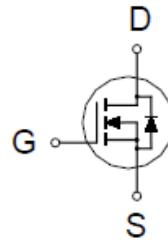
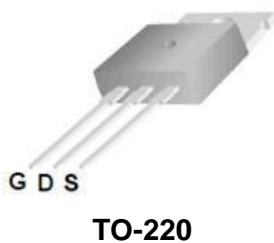


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N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
100V	140mΩ @ $V_{GS} = 10V$	11A



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current	$T_C = 25^\circ C$	I_D	11	A
	$T_C = 100^\circ C$		6.8	
Pulsed Drain Current ¹		I_{DM}	30	A
Avalanche Current		I_{AS}	9.7	
Avalanche Energy	$L = 0.1mH$	E_{AS}	4.7	mJ
Power Dissipation	$T_C = 25^\circ C$	P_D	38	W
	$T_C = 100^\circ C$		15	
Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		3.3	°C / W
Junction-to-Ambient	$R_{\theta JA}$		62.5	

¹Pulse width limited by maximum junction temperature.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.3	1.9	2.3	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
		$V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$			10	
Drain-Source On-State Resistance ¹	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 5\text{A}$		102	170	$\text{m}\Omega$
		$V_{\text{GS}} = 10\text{V}, I_D = 5\text{A}$		91	140	
Forward Transconductance ¹	g_{fs}	$V_{\text{DS}} = 10\text{V}, I_D = 5\text{A}$		13		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1\text{MHz}$		335		pF
Output Capacitance	C_{oss}			60		
Reverse Transfer Capacitance	C_{rss}			26		
Total Gate Charge ²	Q_g	$V_{\text{DS}} = 50\text{V}, I_D = 5\text{A}, V_{\text{GS}} = 10\text{V}$		8.8		nC
Gate-Source Charge ²	Q_{gs}			1.6		
Gate-Drain Charge ²	Q_{gd}			3.8		
Turn-On Delay Time ²	$t_{\text{d(on)}}$	$V_{\text{DS}} = 50\text{V}$ $I_D \approx 5\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		22		nS
Rise Time ²	t_r			60		
Turn-Off Delay Time ²	$t_{\text{d(off)}}$			30		
Fall Time ²	t_f			40		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$)						
Continuous Current	I_S	$I_F = 5\text{A}, V_{\text{GS}} = 0\text{V}$ $I_F = 5\text{A}, \frac{dI_S}{dt} = 100\text{A}/\mu\text{s}$			11	A
Forward Voltage ¹	V_{SD}				1.1	V
Reverse Recovery Time	t_{rr}			28		nS
Reverse Recovery Charge	Q_{rr}			31		nC

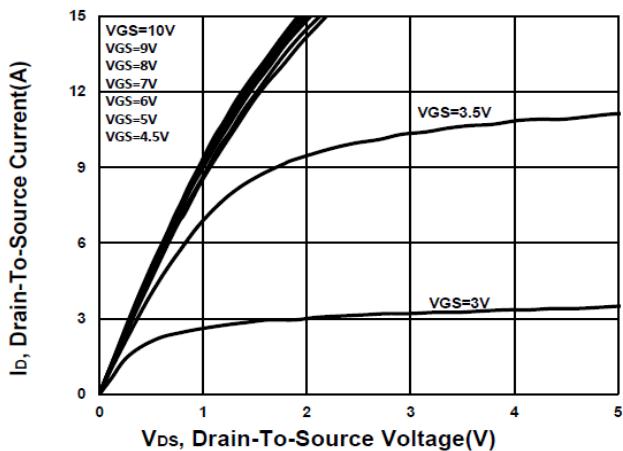
¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

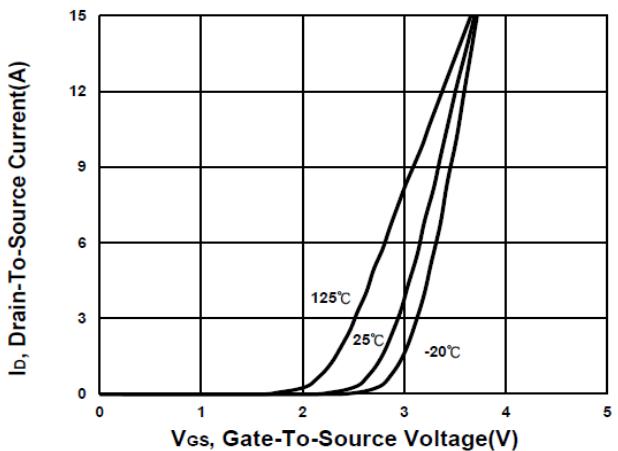
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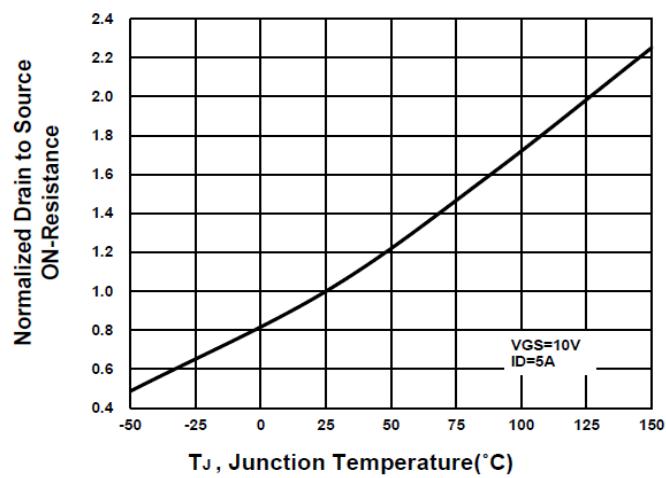
Output Characteristics



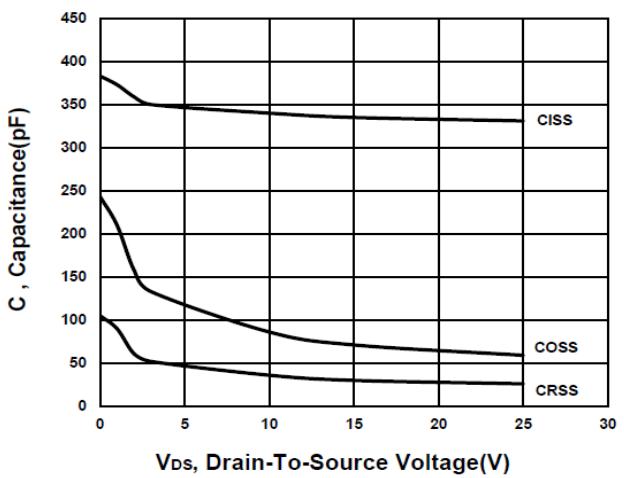
Transfer Characteristics



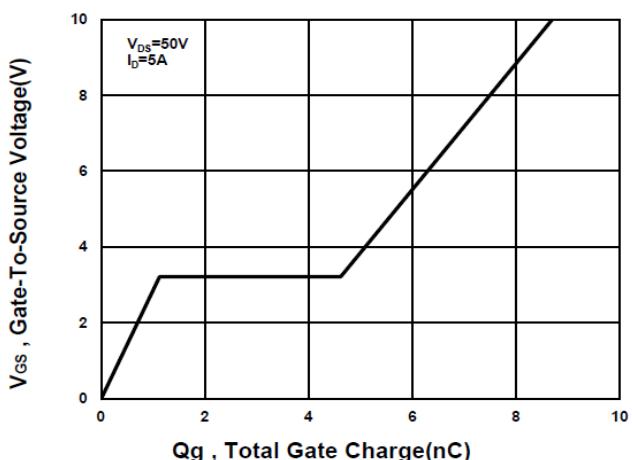
On-Resistance VS Temperature



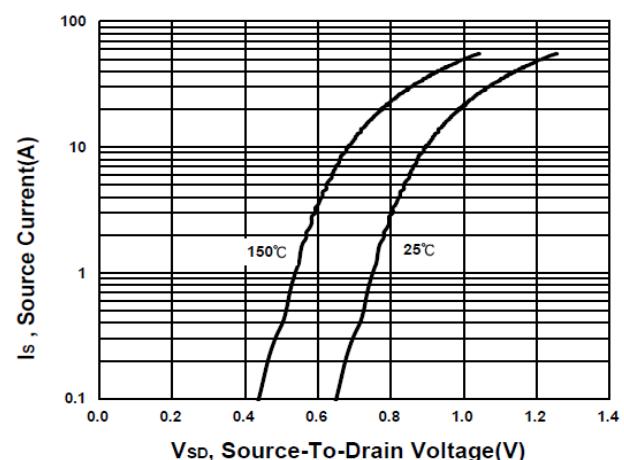
Capacitance Characteristic



Gate charge Characteristics

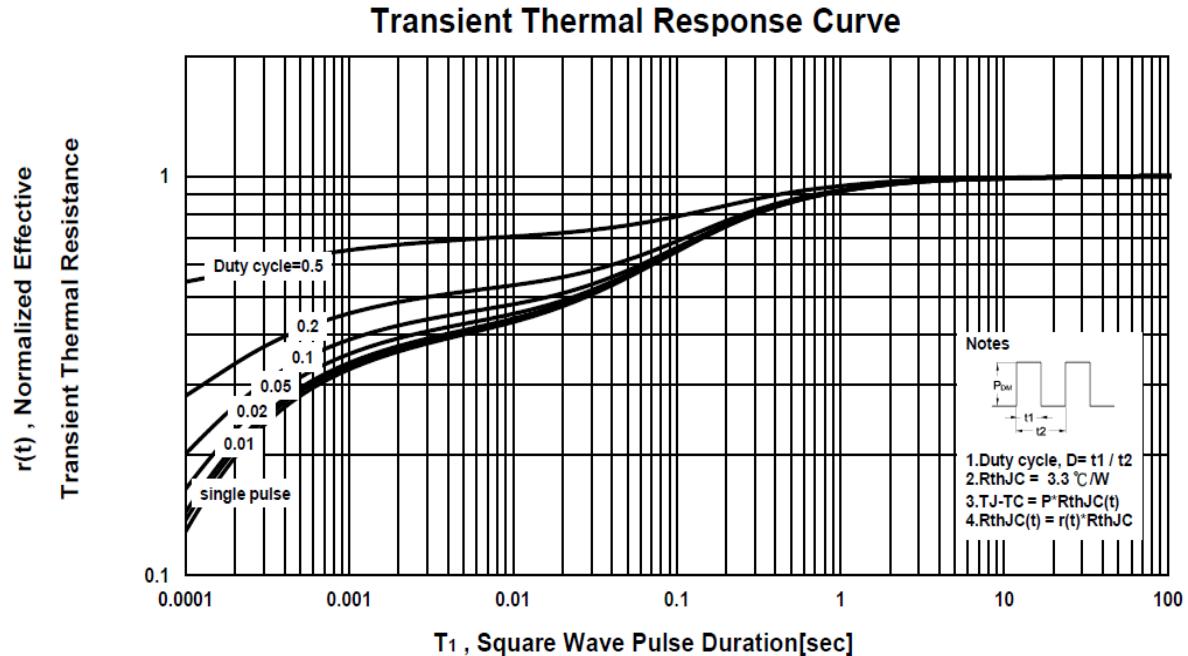
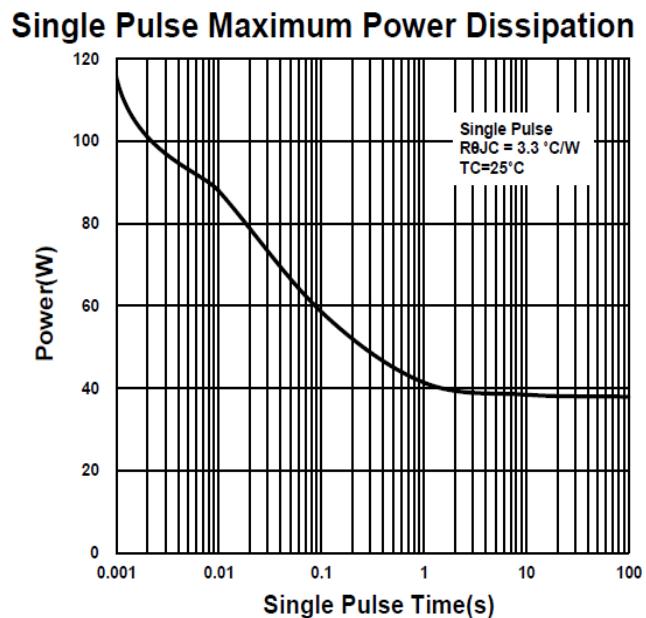
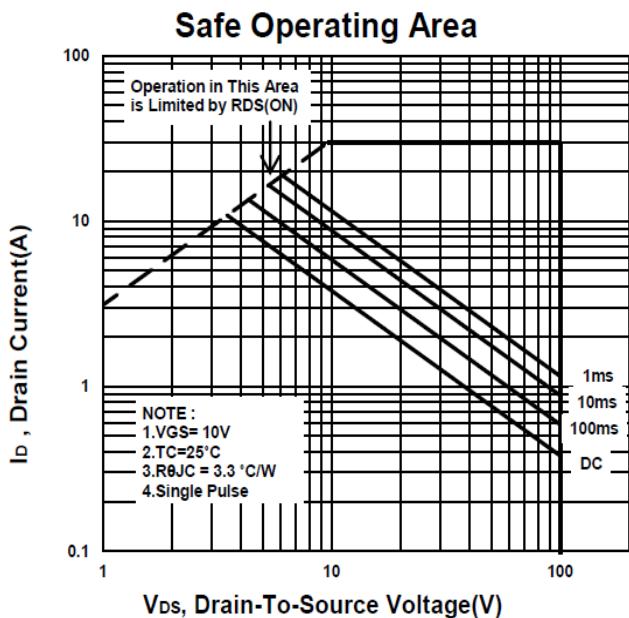


Source-Drain Diode Forward Voltage



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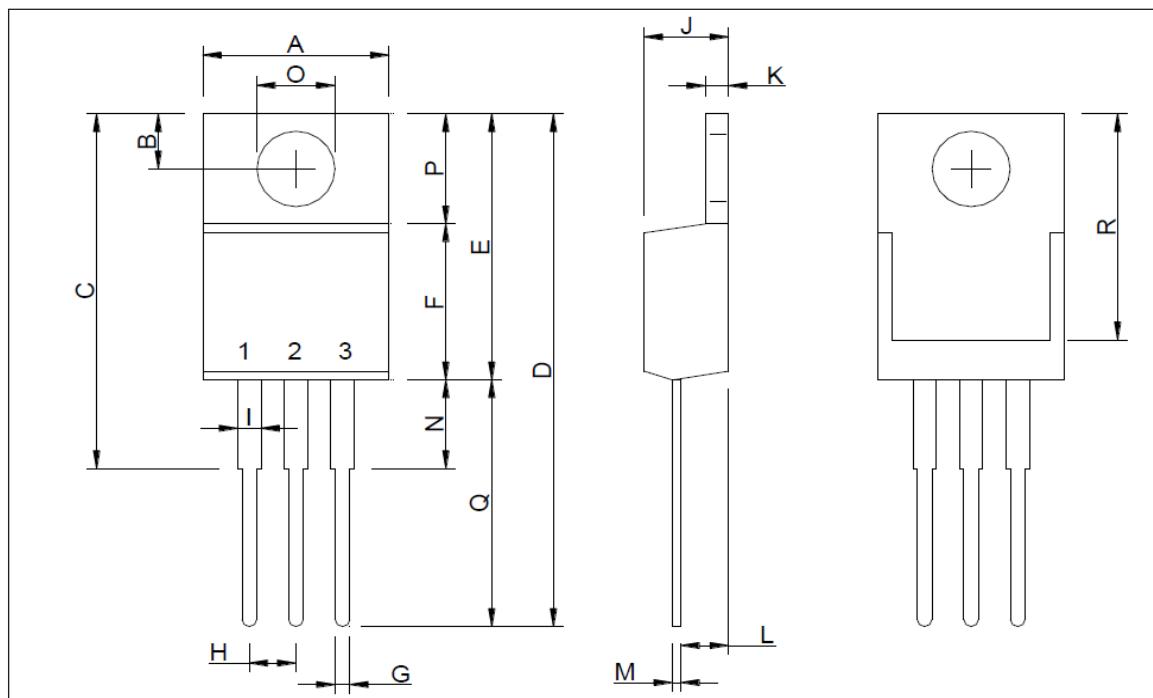
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Package Dimension

TO-220 (3-Lead) MECHANICAL DATA

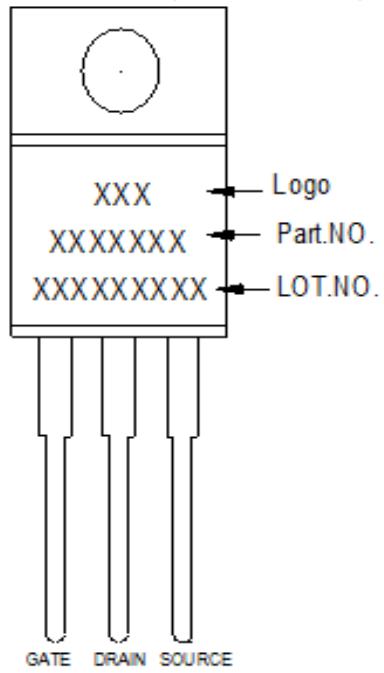
Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	9.65		11.5	J	3.55		4.83
B		2.54		K	1.11		1.45
C	18.1		22.86	L	1.89		3.09
D	26.9		31.24	M	0.34		0.61
E	14.32		16.51	N	2.6		4.06
F	8.38		9.3	O		3.7	
G	0.38		1.02	P	5.84		6.85
H	2.04	2.54	3.04	Q	12.5		14.73
I	1.14		1.8	R	11.3		13.31



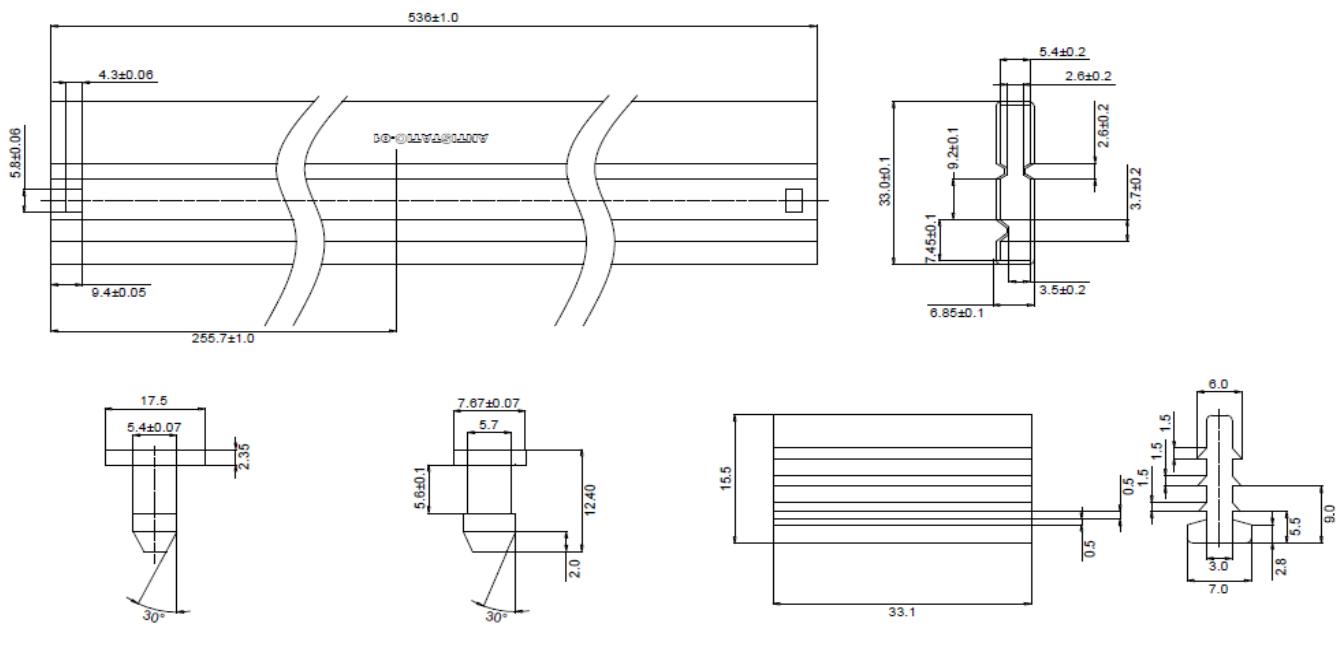
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A. Marking Information



B. Tape&Reel Information: 50pcs/Tube

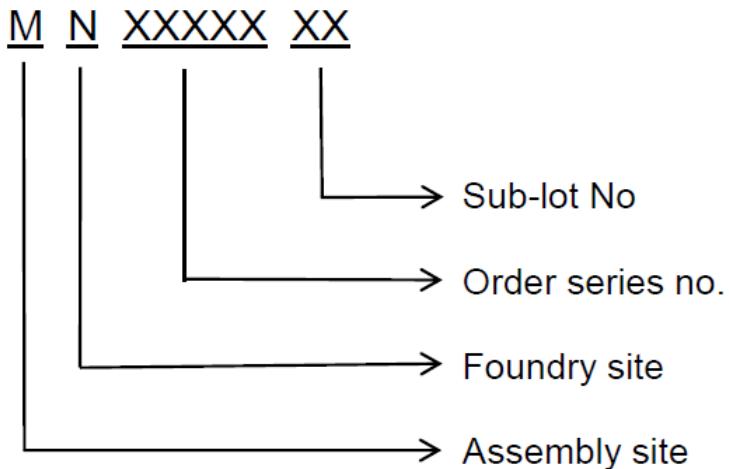


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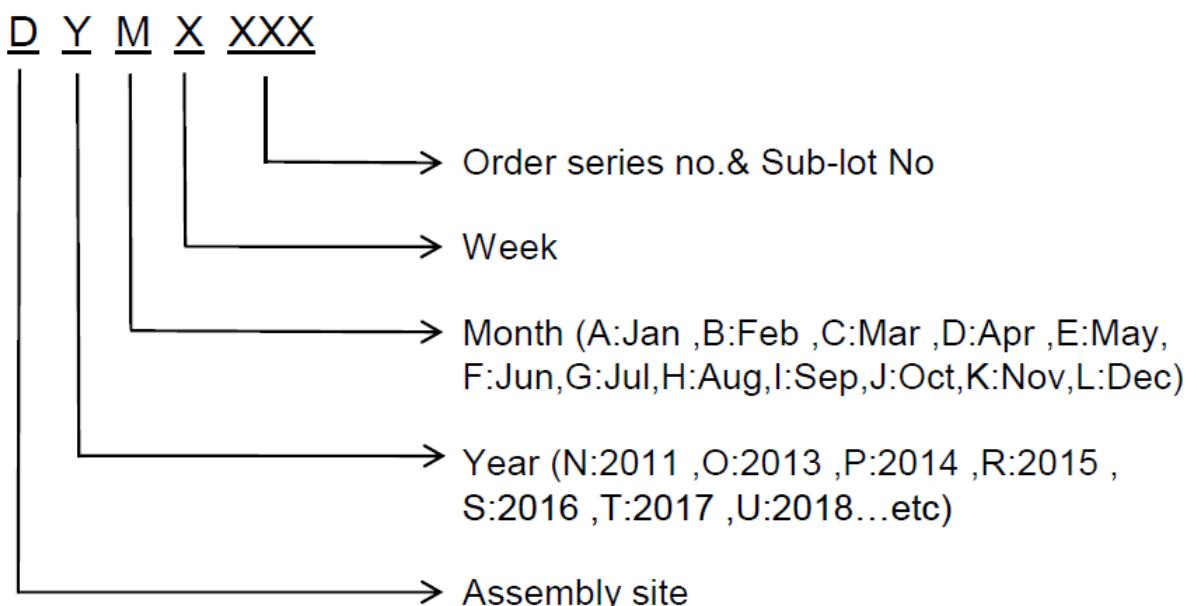
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C. Lot No.&Date Code rule

1. Lot No.



2. Date Code



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D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm		
2	Font style	Times New Roman or Arial (或可区分英文“0”和数字“0”，“G”和“Q”的字型即可)		
3	U-NIKC	Height: 4 mm		
4	Package	Height: 2 mm		
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12		
6	Device	Height: 3 mm (Max: 16 Digit)		
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot		
8	D/C	Height: 3 mm (Max: 7 Digit)		
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed		
10	RoHS label	 long axis: 12 mm minor axis: 6 mm bottom color: White Font color: Black Font style: Arial		
11	Halogen Free label	 Diameter: 10 mm bottom color: Green Font color: Black Font style: Arial		
12	Scan information	Device / Lot / D/C / QTY , Insert “ / ” between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least		